

PMEG050T150EPD

50V, 15 A low VF Trench MEGA Schottky barrier rectifier
27 June 2016 Product data sheet

1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier, encapsulated in a CFP15 (SOT1289) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 15 A
- Reverse voltage: V_R ≤ 50 V
- Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.78 mm
- AEC-Q101 qualified

3. Applications

- · High efficiency DC-to-DC conversion
- Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- · Low power consumption application

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	square wave; δ = 0.5 ; f = 20 kHz; $T_{sp} \le 145 ^{\circ}\text{C}$	-	-	15	Α
V_R	reverse voltage	T _j = 25 °C	-	-	50	V
V _F	forward voltage	I_F = 15 A; $t_p \le 300 \ \mu s$; δ ≤ 0.02 ; T_j = 25 °C; pulsed	-	480	550	mV
I _R	reverse current	V_R = 10 V; $t_p \le 3$ ms; $\delta \le 0.03$; T_j = 25 °C; pulsed	-	16	50	μA
		V_R = 50 V; $t_p \le 3$ ms; $\delta \le 0.03$; T_j = 25 °C; pulsed	-	34	100	μA



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		⊬ <mark>E</mark> M □ A
2	А	anode		A aaa-009063
3	K	cathode	2	add 000000
			CFP15 (SOT1289)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PMEG050T150EPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289		

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG050T150EPD	050T U15E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	50	V
I _F	forward current	T _{sp} = 140 °C; δ = 1		-	21	Α
I _{F(AV)}	average forward current	square wave; δ = 0.5 ; f = 20 kHz; $T_{sp} \le$ 145 °C		-	15	А
I _{FSM}	non-repetitive peak forward current	square wave; t_p = 8 ms; $T_{j(init)}$ = 25 °C		-	210	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
			[3]	-	3.5	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

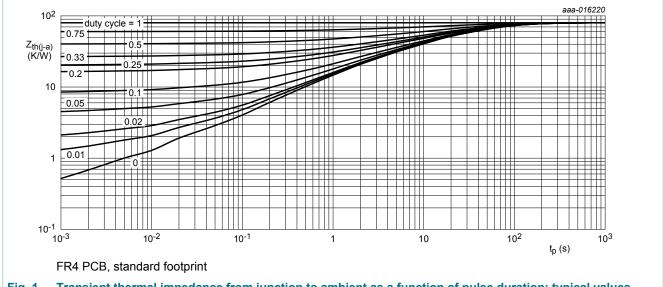
Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
uily a)	thermal resistance from junction to ambient		[1][2]	-	-	90	K/W
			[1][3]	-	-	70	K/W
			[1][4]	-	-	42	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[5]</u>	-	-	3	K/W

- For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.



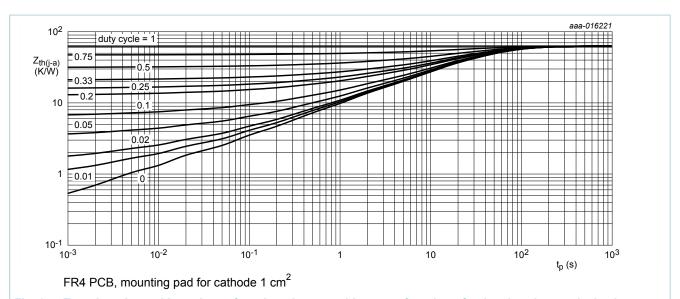


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

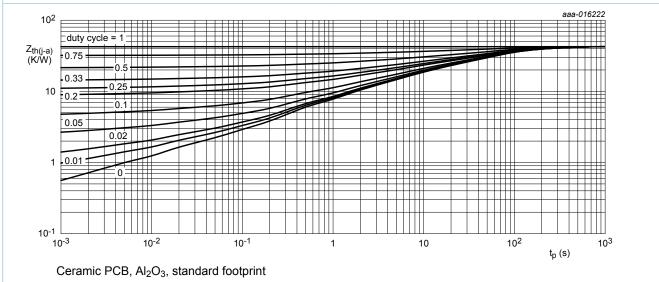


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 5 \text{ mA}; T_j = 25 \text{ °C}; t_p \le 1.2 \text{ ms}; \delta \le 0.12; \text{ pulsed}$	50	-	-	V	
V _F	V _F	forward voltage	$I_F = 1 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	320	380	mV
		$I_F = 5 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	390	460	mV	
		I_F = 10 A; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; T_j = 25 °C; pulsed	-	440	-	mV	
		I_F = 15 A; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; T_j = 25 °C; pulsed	-	480	550	mV	
		I_F = 15 A; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; T_j = 125 °C; pulsed	-	405	-	mV	
I _R	reverse current	V_R = 5 V; $t_p \le 3$ ms; $\delta \le 0.03$; T_j = 25 °C; pulsed	-	12	-	μA	
		$V_R = 10 \text{ V; } t_p \le 3 \text{ ms; } \delta \le 0.03 \text{ ;} $ $T_j = 25 ^{\circ}\text{C; pulsed}$	-	16	50	μA	
		$V_R = 50 \text{ V; } t_p \le 3 \text{ ms; } \delta \le 0.03 \text{ ;} $ $T_j = 25 ^{\circ}\text{C; pulsed}$	-	34	100	μA	
		V_R = 50 V; $t_p \le 3$ ms; $\delta \le 0.03$; T_j = 125 °C; pulsed	-	22	-	mA	
C_d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	2200	-	pF	
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	800	-	pF	
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}$	-	60	-	ns	
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	305	-	mV	

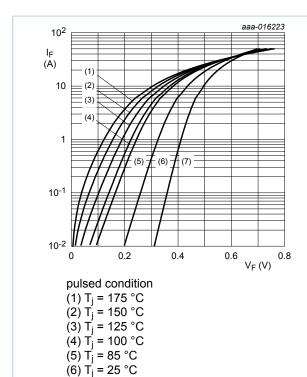


Fig. 4. Forward current as a function of forward voltage; typical values

 $(7) T_i = -40 ^{\circ}C$

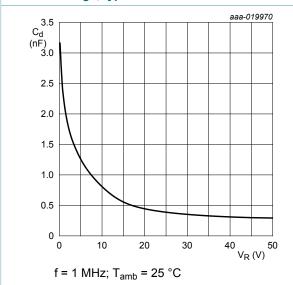


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

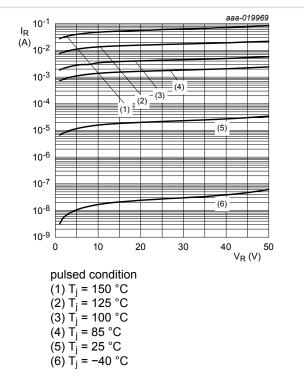
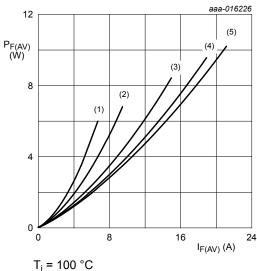


Fig. 5. Reverse current as a function of reverse voltage; typical values



 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 0.1$ $(2) \, \delta = 0.2$ $(3) \, \delta = 0.5$ $(4) \, \delta = 0.8$ $(5) \, \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

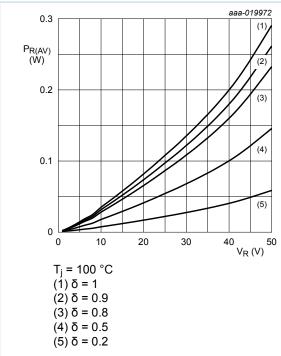
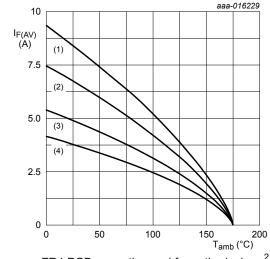


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_j = 175 \,{}^{\circ}\text{C}$

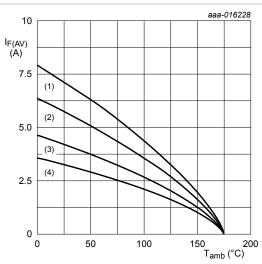
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



FR4 PCB, standard footprint

T_i = 175 °C

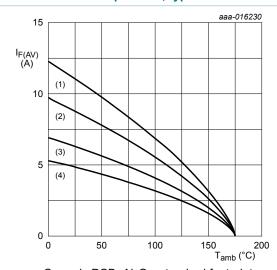
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

T_i = 175 °C

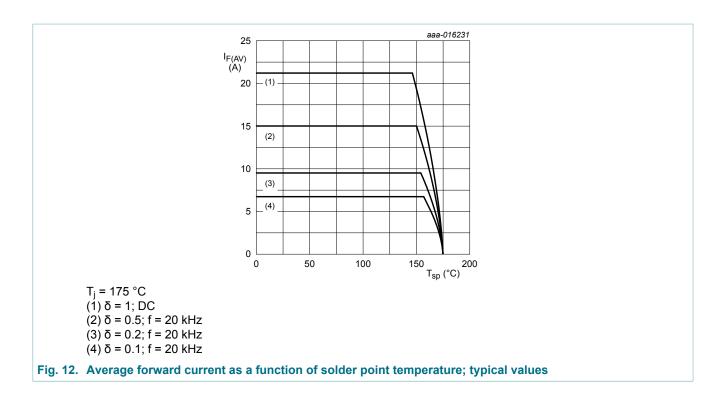
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

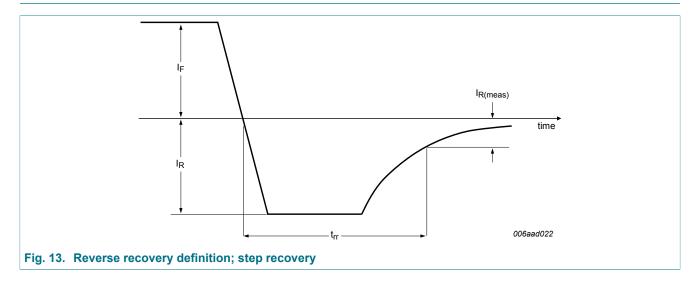
(3) δ = 0.2; f = 20 kHz

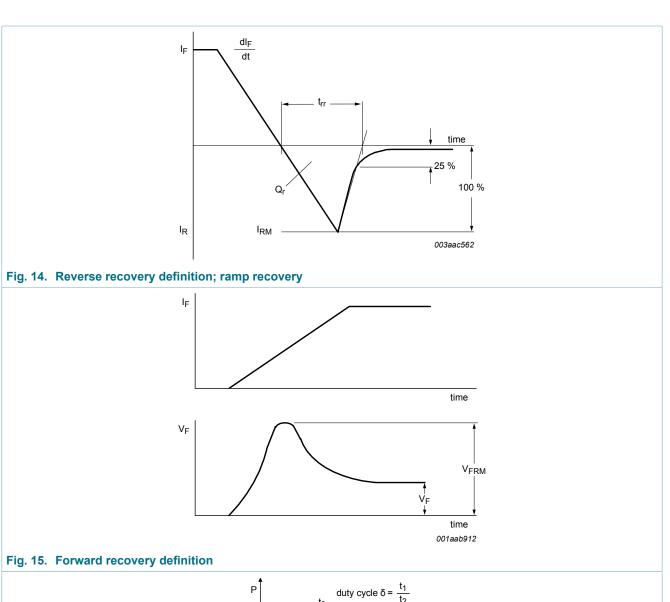
(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



11. Test information





t 006aaa812

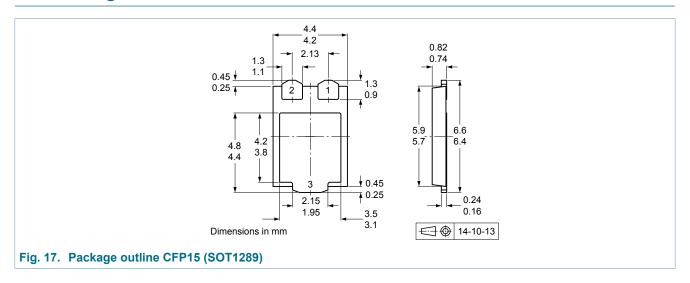
Fig. 16. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_{M} \times \delta$ with I_{M} defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

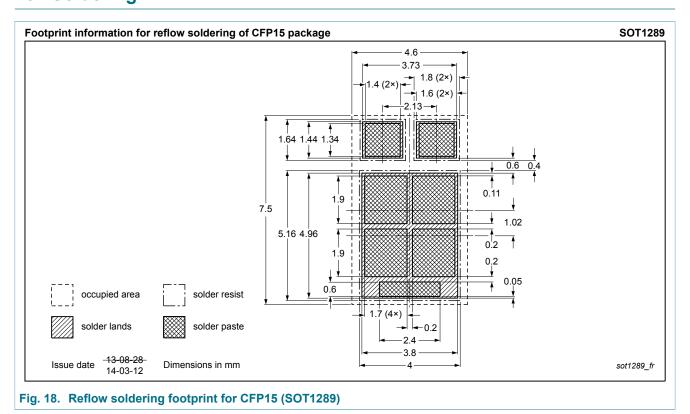
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG050T150EPD v.3	20160627	Product data sheet	-	PMEG050T150EPD v.2
Modification:	Section 7: Mar	king code corrected		
PMEG050T150EPD v.2	20151218	Product data sheet	-	PMEG050T150EPD v.1
PMEG050T150EPD v.1	20150930	Preliminary data sheet		

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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